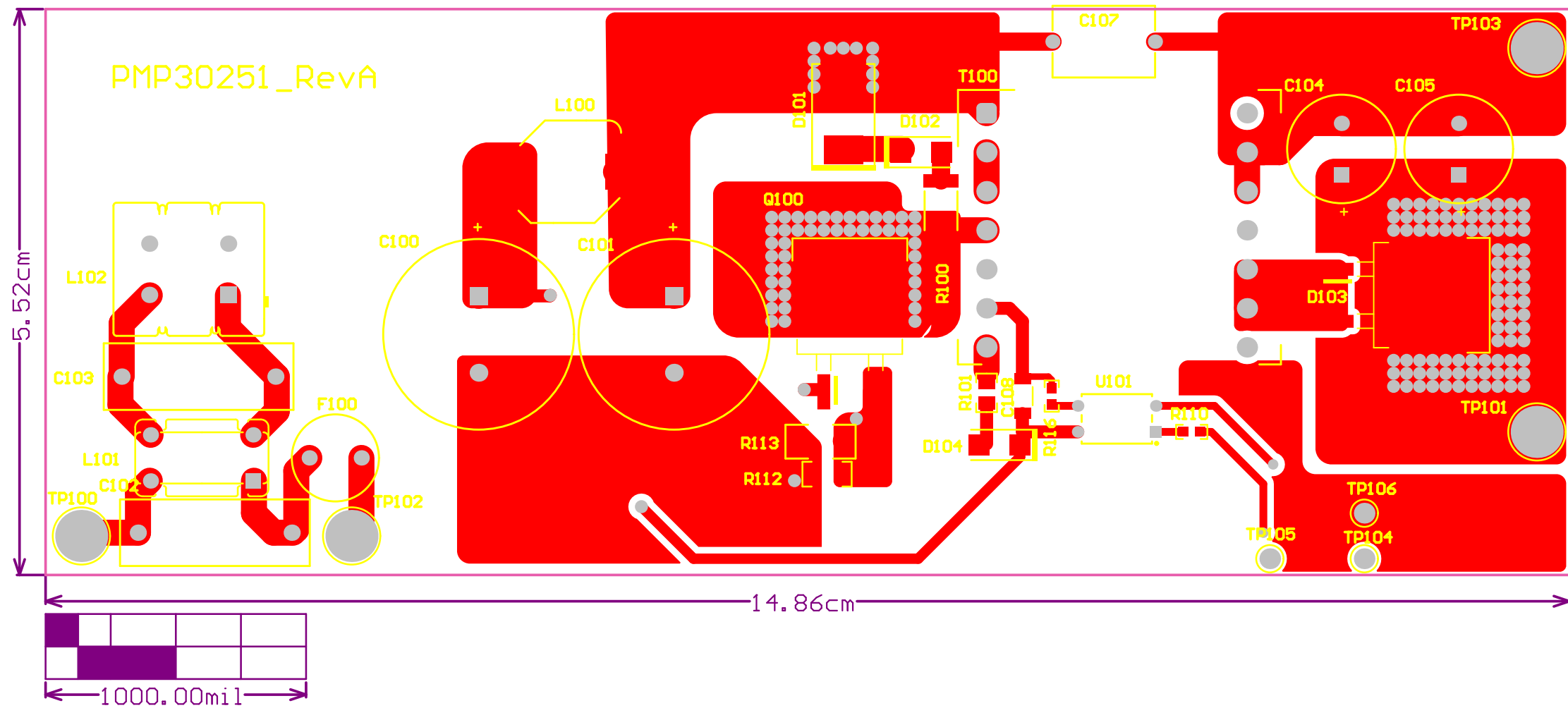




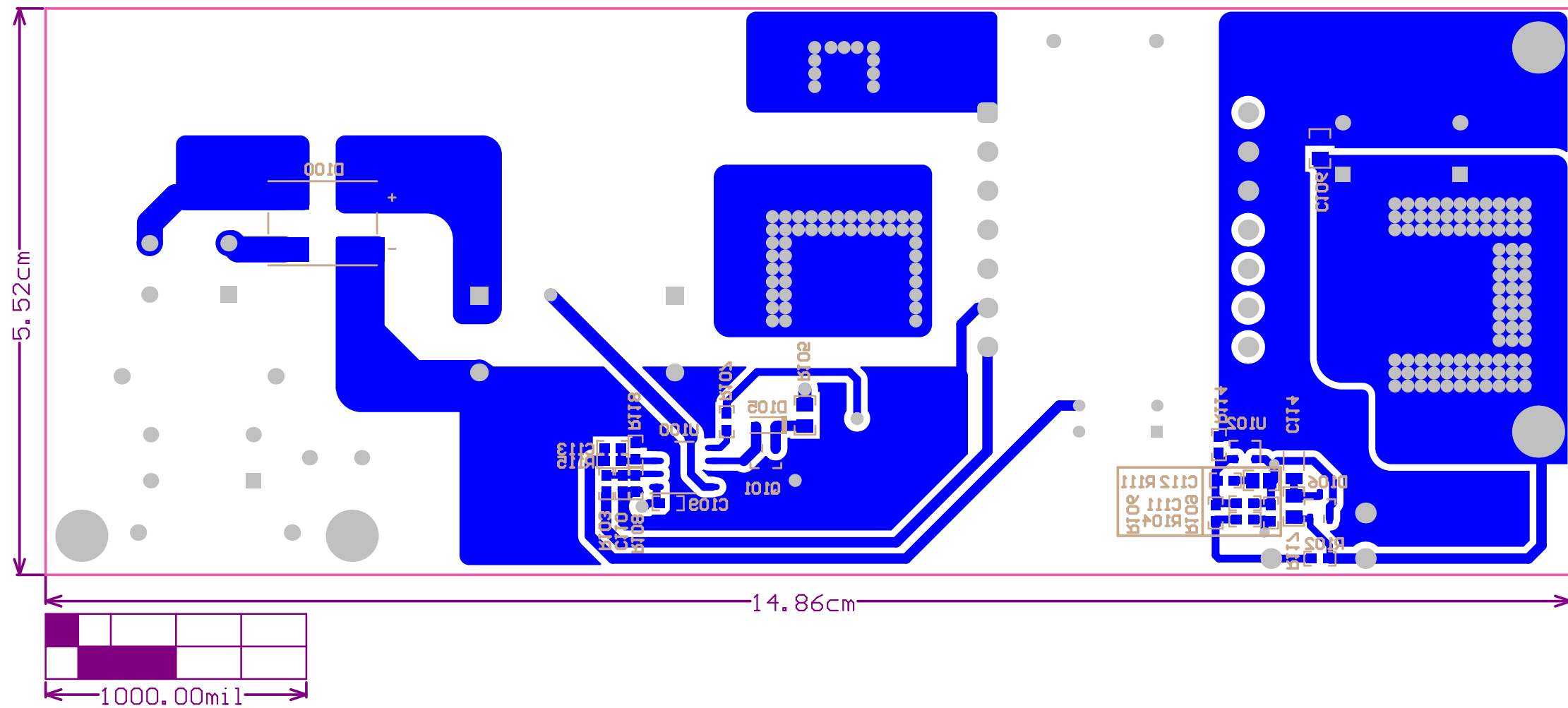
Top Board Dimensions



M1 Board Outline



M1 Board Outline



5. PCB Dimensions

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Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265
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